Patent Claims

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- 1. A surface paneling module
- least one electrical power supply having at connection,
- having at least one data transmission interface,
- having at least one processor unit which coupled to the electrical power supply connection and to the data transmission interface,
- 10 in which the processor unit is designed such that electronic messages are interchanged between the processor unit and a processor unit adjacent surface paneling module, which is coupled to the surface paneling module, in order to 15 determine the respective distance of a processor unit from a reference position
 - with each message containing distance information which indicates the distance of the surface paneling module of a processor unit which is sending the message or the distance of the surface paneling module of a processor unit which receiving the message from the reference position, and
- with the processor unit being designed such that 25 the actual distance to the reference position can be determined or can be stored from the distance information in a received message.
- The surface paneling module as claimed in claim 1, having a plug connector in which the electrical power 30 supply connection and the data transmission interface are integrated.
- The surface paneling module as claimed in claim 1 or 2, having at least one electrical power line and at 35 least one data line, wherein the processor unit is coupled to the electrical power supply connection by means of the electrical power line, and is coupled to

the data transmission interface by means of the data line.

The surface paneling module as claimed in one of 4. claims 1 to 3,

designed as one of the following modules:

- wall paneling module, or
- floor paneling module, or
- ceiling paneling module.

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The surface paneling module as claimed in one of claims 1 to 3,

designed as

- a tile, or
- 15 a wall tile, or
 - a parquet flooring element, or
 - a laminate element.
- The surface paneling module as claimed in one of 20 claims 1 to 5,

having at least one sensor which is coupled to the processor unit.

The surface paneling module as claimed in one of 25 claims 1 to 6,

having at least one of the following elements, which is coupled to the processor unit,

- imaging element, or
- sound wave production element, or
- 30 vibration production element.
 - A surface paneling module arrangement having two or more surface paneling modules as claimed in one of claims 1 to 7, which are coupled to one another by means of the electrical power supply connection and the data transmission interface.
 - A method for determining a distance from surface 9.

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paneling modules of the surface paneling module arrangement as claimed in claim 1 to at least one reference position, with electronic messages being interchanged between processor units of mutually adjacent surface paneling modules,

- in which a first message is produced by a processor unit of a first surface paneling module, with the first message containing first distance information which contains the distance of the first surface paneling module or the distance of a second surface paneling module which receives the first message from the reference position,
- in which the first message is sent from the processor unit of the first surface paneling module to the processor unit of the second surface paneling module,
- in which the distance of the processor unit of the second surface paneling module from the reference position is determined or stored as a function of the distance information,
- in which the processor unit of the second surface paneling module produces a second message which contains second distance information which contains the distance of the second surface paneling module or the distance of a third surface paneling module which receives the second message, from the reference position,
- in which the second message is sent from the processor unit of the second surface paneling module to the processor unit of the third surface paneling module,
- in which the distance of the third surface paneling module from the reference position is determined or stored as a function of the second distance information,
- in which the method steps are carried out for all the surface paneling modules in the surface paneling module arrangement.

- The method as claimed in claim 9, in which, before the determination of the distance of surface paneling modules from the reference 5 position, the physical positions of the paneling modules within the surface paneling module arrangement are determined in that, on the basis of a surface paneling module at an introduction point of the surface paneling module arrangement, position 10 determination messages which have at least one row parameter z and one column parameter s (which contains the row number or column number, respectively, of the processor unit sending the message or the row number or the column number, respectively, of the processor unit 15 receiving the message within the surface paneling module arrangement) are in each case transmitted to processor units of adjacent surface paneling modules, and the respective processor unit carries out the following steps:
- 20 if the row parameter in the received message is greater than the previously stored row number of the processor unit, then the processor unit's own row number is allocated the row parameter value z of the received message,
- 25 if the column parameter in the received message is than the processor unit's own greater number, then the stored column number is allocated the row parameter value of the received message,
- if its own row number and/or its own column number 30 have/has been changed on the basis of the method described above, then new position steps measurement messages are produced with new row parameters and new column parameters, which each contain the row number and the column number of 35 the processor unit sending the message or the row number and the column number of the processor unit receiving the message, and these are transmitted to a processor unit of a respective adjacent

surface paneling module.

- 11. The method as claimed in claim 9 or 10,
- in which, in an iterative method, the processor unit of the surface paneling module's own distance value is changed if the previously stored distance value is greater than the received distance value (increased by a predetermined value) in the respectively received message, and
- 10 in which, in the situation where a processor unit of a surface paneling module changes distance value, this produces distance а measurement message and sends this to processor units of adjacent surface paneling modules, with 15 the distance measurement message in each case containing its own distance distance as the distance value which information or receiving processor unit has from the portal processor.

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12. The method as claimed in claim 11, in which the distance value has a value which is greater by a predetermined value than its own distance value.

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- A processor arrangement,
- having at least one interface processor which provides a message interface for the processor arrangement,
- having a large number of processors, with, at least in some cases, only those processors which are arranged physically directly adjacent to one another being coupled to one another in order to interchange electronic messages,
- in which each processor of the large number of processors is allocated a sensor and/or an actuator and is coupled to the respective processor with sensor data and/or actuator data

being transmitted in the electronic messages from and/or to the interface processor, and

- with the processors which are arranged physically 5 directly adjacent to one another at least in some cases being coupled to one another in accordance with a regular coupling topology whose degree is greater than unity.
- 10 The processor arrangement as claimed in claim 13, in which the processors which are arranged physically directly adjacent to one another are coupled to one another in accordance with a regular bus coupling topology.

The processor arrangement as claimed in claim 13, in which the processors which are arranged physically directly adjacent to one another are coupled to one another in accordance with a regular ring coupling

20 topology.

> 16. The processor arrangement as claimed in claim 14 or 15,

in which the regular bus coupling topology is designed in accordance with one of the following communication 25 interface standards:

- serial parallel interface,
- controller area network interface, or
- I²C interface.

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The processor arrangement as claimed in one of claims 13 to 16,

in which the processors are arranged in rows and columns in the form of a matrix.

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- A textile fabric structure having a processor arrangement as claimed in one of claims 13 to 17,
- in which the processors and/or sensors and/or

actuators are arranged in the textile fabric structure,

- having electrically conductive threads which couple the processors to one another,
- having conductive data transmission threads which couple the processors to one another, and
 - having electrically non-conductive threads.
- 19. The textile fabric structure as claimed in 10 claim 18,

in which the electrically conductive threads are designed such that they can be used to supply power to the two or more processors and/or sensors and/or actuators.

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20. The textile fabric structure as claimed in claim 18 or 19,

in which the conductive data transmission threads are electrically conductive.

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21. The textile fabric structure as claimed in claim 18 or 19,

in which the conductive data transmission threads are optically conductive.

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22. The textile fabric structure as claimed in one of claims 18 to 21,

in which the actuator is designed as at least one of the following elements:

- 30 imaging element, or
 - sound wave production element, or
 - vibration production element.
 - 23. A surface paneling structure,
- 35 in which surface paneling is fixed on a textile fabric structure as claimed in one of claims 6 to 10.
 - 24. The surface paneling structure as claimed in

claim 23,

in which the surface paneling is adhesively bonded and/or laminated and/or vulcanized onto the textile fabric structure.

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25. The surface paneling structure as claimed in claim 23 or 24,

in which the surface paneling structure is designed as

- wall paneling structure, or
- floor paneling structure, or 10
 - ceiling paneling structure.
 - 26. The surface paneling structure as claimed in one of claims 23 to 25,
- in which a textile layer through which electrically 15 conductive wires pass uniformly is applied at least over subareas of the textile fabric structure.